



Docket No. 532432000200

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the application of:

Jie LIU et al.

Serial No.: 09/901,143

Filing Date: July 10, 2001

For: MOLDING APPARATUS

Examiner: Timothy W. Heitbrink

Group Art Unit: 1722

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AMENDMENT UNDER 37 CFR 1.111

Mail Stop Non-Fee Amendment
Commissioner for Patents
2011 South Clark Place
Room 1B03, Crystal Plaza 2
Arlington, VA 22202

Sir:

In response to the office action mailed May 12, 2003, please amend the application as follows:

IN THE DRAWINGS

The attached sheet of drawings includes changes to Figures 2-3. Figure 1, which is not being amended, is also attached.